

Title (en)
ADHESIVE SYSTEM AND METHOD

Title (de)
KLEBSYSTEM UND ENTSPRECHENDES VERFAHREN

Title (fr)
SYSTEME ADHESIF ET PROCEDE

Publication
EP 1907500 A2 20080409 (EN)

Application
EP 06748073 A 20060630

Priority
• SE 2006050234 W 20060630
• EP 05106006 A 20050701
• EP 06748073 A 20060630

Abstract (en)
[origin: WO2007004978A2] The invention relates to an adhesive composition comprising at least partly gelatinised starch and one or more polymers (P) containing an amine group or an amide group. It also relates to a method of gluing pieces of wood based materials and to a wood based product.

IPC 8 full level
C09J 103/00 (2006.01)

CPC (source: EP NO)
C09J 103/00 (2013.01 - EP NO); **C08L 2666/02** (2013.01 - EP)

Citation (search report)
See references of WO 2007004980A2

Designated contracting state (EPC)
AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HU IE IS IT LI LT LU LV MC NL PL PT RO SE SI SK TR

DOCDB simple family (publication)
WO 2007004978 A2 20070111; WO 2007004978 A3 20070308; AR 056406 A1 20071010; AR 056407 A1 20071010; AU 2006266504 A1 20070111; AU 2006266504 B2 20100902; AU 2006266506 A1 20070111; AU 2006266506 B2 20100916; BR PI0612604 A2 20101207; BR PI0612605 A2 20101207; CA 2612173 A1 20070111; CA 2612173 C 20110517; CA 2612177 A1 20070111; CA 2612177 C 20110308; CN 101208400 A 20080625; CN 101208400 B 20110525; CN 101208401 A 20080625; CN 101208401 B 20130605; EP 1907499 A2 20080409; EP 1907499 B1 20170628; EP 1907500 A2 20080409; JP 2008545042 A 20081211; JP 2008545043 A 20081211; JP 5108756 B2 20121226; JP 5133243 B2 20130130; MY 145705 A 20120330; MY 146033 A 20120615; NO 20080521 L 20080401; NO 20080522 L 20080328; NO 342246 B1 20180430; NZ 564124 A 20100326; NZ 564125 A 20100528; PL 1907499 T3 20171130; RU 2008103819 A 20090810; RU 2008103826 A 20090810; RU 2395553 C2 20100727; RU 2400513 C2 20100927; TW 200712154 A 20070401; TW 200712155 A 20070401; TW I365899 B 20120611; UA 89247 C2 20100111; UA 95779 C2 20110912; WO 2007004980 A2 20070111; WO 2007004980 A3 20070308

DOCDB simple family (application)
SE 2006050231 W 20060630; AR P060102836 A 20060630; AR P060102837 A 20060630; AU 2006266504 A 20060630; AU 2006266506 A 20060630; BR PI0612604 A 20060630; BR PI0612605 A 20060630; CA 2612173 A 20060630; CA 2612177 A 20060630; CN 200680023222 A 20060630; CN 200680023295 A 20060630; EP 06748070 A 20060630; EP 06748073 A 20060630; JP 2008519235 A 20060630; JP 2008519237 A 20060630; MY PI20063139 A 20060630; MY PI20063140 A 20060630; NO 20080521 A 20080128; NO 20080522 A 20080128; NZ 56412406 A 20060630; NZ 56412506 A 20060630; PL 06748070 T 20060630; RU 2008103819 A 20060630; RU 2008103826 A 20060630; SE 2006050234 W 20060630; TW 95123699 A 20060630; TW 95123700 A 20060630; UA A200801214 A 20060630; UA A200801215 A 20060630